### **ACR1004U**

Request Samples (>)



Check Inventory (>)



10.0 x 4.0 x 1.5 mm **RoHS/RoHS II Compliant** MSL Level = N/A

#### **Features**

- UWB 3 GHz ~ 6 GHz
- Compact Profile
- Omni-directional Pattern
- Efficiency > 60%
- Surface Mount (SMD)

## **Applications**

- IoT
- M2M
- PDA/Wearables
- Precision Positioning and Tracking
- Industrial/Medical/Automotive Sensors
- Smart Home/Building

### **Electrical Specifications**

Parameter	Specification			Unit
1 at afficted	Min	Тур	Max	Omt
Operating Frequency	3		6	GHz
Peak Gain*		5.79		dBi
Efficiency	60			%
Impedance	50			Ω
Polarization	Linear			
Radiation Pattern	Omni-directional			

<sup>\*</sup>All test measurements were conducted with antennas on an evaluation board of dimensions 45 x 18 mm.

### **Mechanical Specifications**

Parameter	Specification		
Antenna Dimension	10 x 4 x 1.5 mm		
Material	Ceramic		
Mounting Type*	Surface Mount (SMD)		

<sup>\*</sup>Do not mount the antenna on a metal surface.

### **Environmental Specifications**

Parameter	Specification
Operating Temperature	-30°C to +85 °C
Operating Temperature	-30°C to +85 °C
Relative Humidity	0~95%



### **ACR1004U**

Request Samples (>)

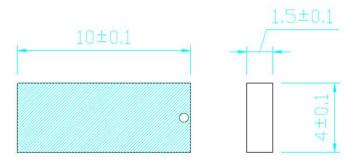


Check Inventory (>)



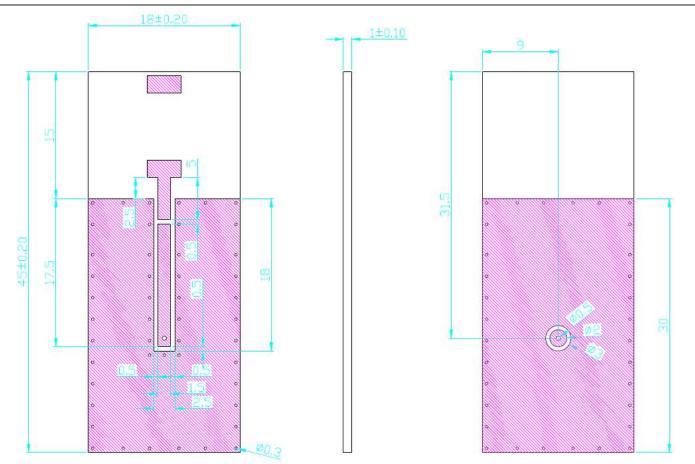
10.0 x 4.0 x 1.5 mm **RoHS/RoHS II Compliant** MSL Level = N/A

#### **Antenna Dimensions**



Unit: mm

### **Layout Dimensions on Evaluation Board**



Unit: mm



5101 Hidden Creek Ln Spicewood TX 78669 Phone: 512-371-6159 | Fax: 512-351-8858 For terms and conditions of sales, please visit: www.abracon.com

**REVISED: 01-03-20** 

ABRACON IS ISO9001-2015 CERTIFIED

### **ACR1004U**

Request Samples (>)

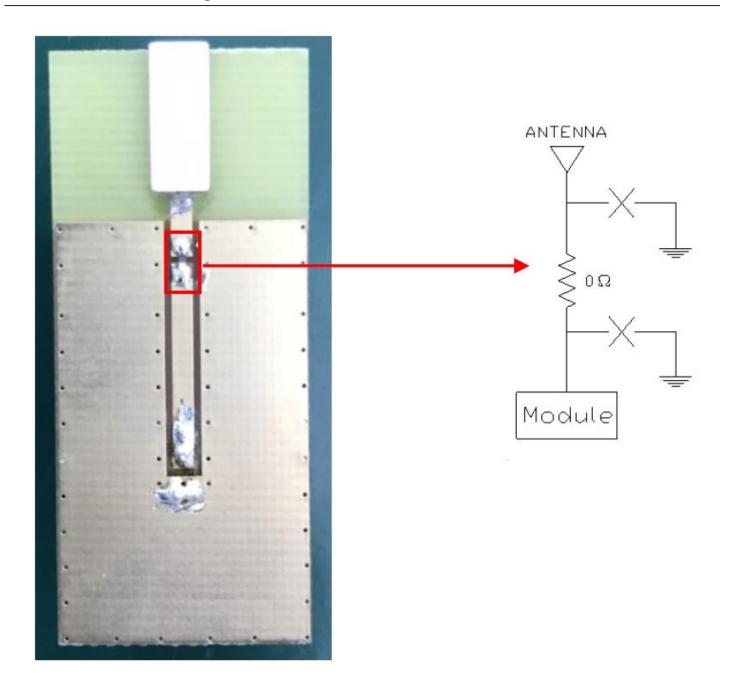


Check Inventory (>)



10.0 x 4.0 x 1.5 mm **RoHS/RoHS II Compliant** MSL Level = N/A

### **Evaluation Board with Matching Circuit**





**ACR1004U** 

Request Samples (>)

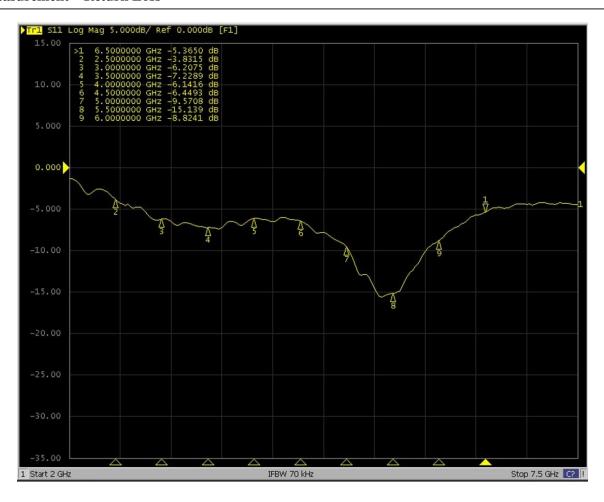


Check Inventory (>)



10.0 x 4.0 x 1.5 mm **RoHS/RoHS II Compliant** MSL Level = N/A

#### Test Measurement - Return Loss





**ACR1004U** 

Request Samples (>)

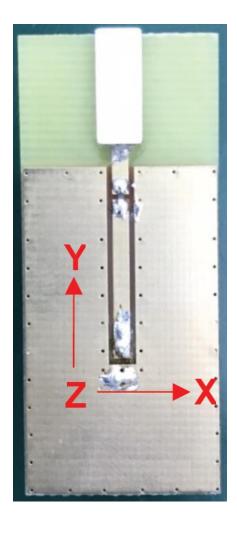


Check Inventory (>)



10.0 x 4.0 x 1.5 mm **RoHS/RoHS II Compliant** MSL Level = N/A

## **Radiation Measurement - Set-up**





### **ACR1004U**

Request Samples (>)

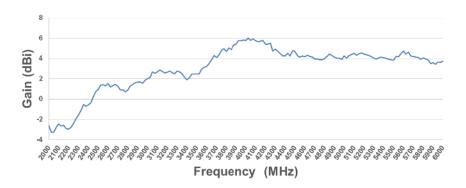


Check Inventory (>)

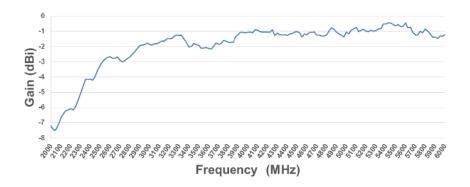


10.0 x 4.0 x 1.5 mm **RoHS/RoHS II Compliant** MSL Level = N/A

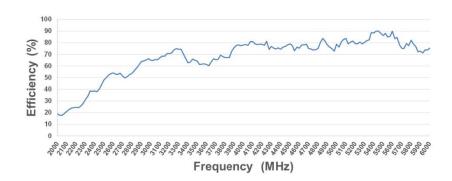
#### Peak Gain



### **Average Gain**



### **Efficiency**



Frequency (GHz)	3	3.5	4	4.5	5	5.5	6
Efficiency (%)	65.03	64.11	78.21	79.03	78.62	86.07	75.20
Average Gain (dBi)	-1.86	-1.93	-1.06	-1.02	-1.04	-0.65	-1.23
Peak Gain (dBi)	2.01	2.48	5.79	4.70	4.24	3.83	3.72



### **ACR1004U**

Request Samples (>)



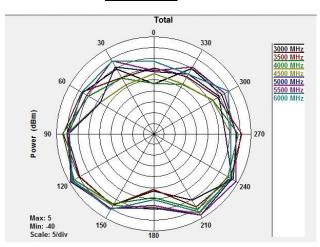
Check Inventory (>)



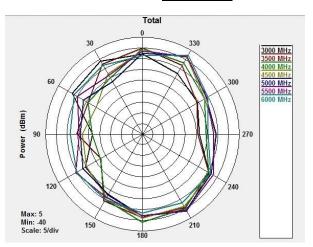
10.0 x 4.0 x 1.5 mm **RoHS/RoHS II Compliant** MSL Level = N/A

### **Radiation Characteristics – 2D Pattern**

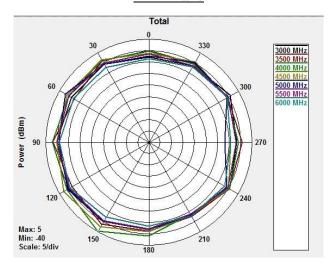
XY - Plane



XZ - Plane



YZ - Plane





### **ACR1004U**

Request Samples (>)

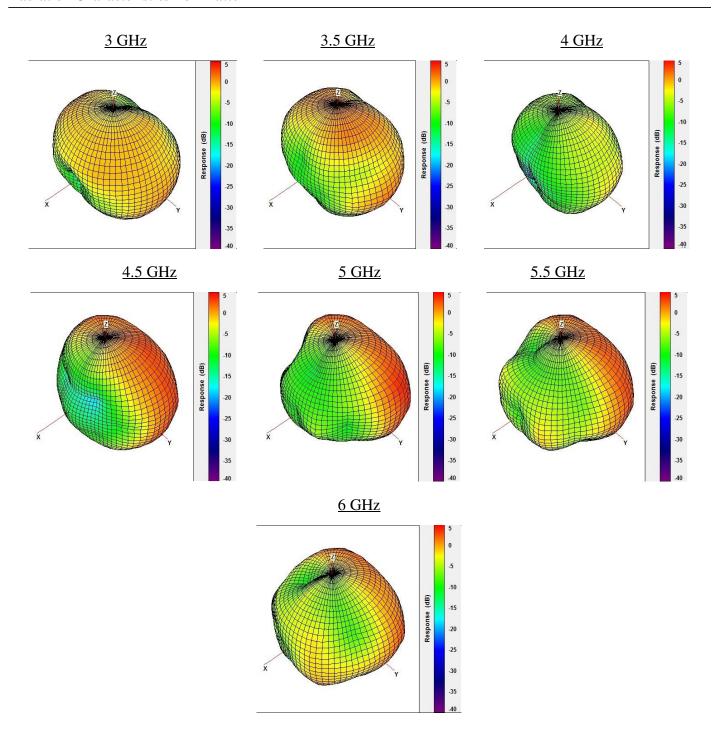


Check Inventory (>)



10.0 x 4.0 x 1.5 mm **RoHS/RoHS II Compliant** MSL Level = N/A

### Radiation Characteristics – 3D Pattern





### **ACR1004U**

Request Samples (>)



Check Inventory (>)



10.0 x 4.0 x 1.5 mm **RoHS/RoHS II Compliant** MSL Level = N/A

## **Reliability Test Conditions**

Items	Test Method	Standard
Sinusoidal Vibration Test  Vibration Test in Packaged Condition	<ol> <li>Vibration Frequency: 5-200-5 Hz</li> <li>Peak: 4.5G (2 mm amplitude)</li> <li>Sweep Direction: X, Y (2H), Z (4H)</li> <li>Sweep Duration: 10 min/axis</li> <li>Examine the appearance and functions after the test.</li> <li>Vibration Frequency: 15-60-15 Hz</li> <li>Peak: 4G (2 mm amplitude)</li> <li>Sweep Direction: X, Y, Z</li> <li>Sweep Duration: 10 min/axis</li> <li>Examine the appearance and functions after the test.</li> </ol>	<ol> <li>Specimens shall be free of any traffic discontinuities during the test.</li> <li>The appearance of the product, and electrical properties to meet the requirements.</li> </ol>
Thermal Shock Free Fall Test	<ol> <li>Low temperature: -30°C</li> <li>High temperature: +85°C</li> <li>Cycle time: 30 min each temperature</li> <li>Number of Cycles: 5</li> <li>Expose to normal temperature/humidity for 24H or more.</li> <li>Drop the object onto a concrete surface from a height of 90 cm.</li> </ol>	
in Packaged	2. Test once for one corner, three edges and six faces: 10 times in total.	
Condition  High Temperature	<ol> <li>Examine the appearance and functions after the test.</li> <li>Temperature: 85°C</li> <li>Time: 16H</li> <li>Examine the appearance and functions after taken out at room temperature for 24H.</li> </ol>	The appearance of the
Low Temperature	<ol> <li>Temperature: -30°C</li> <li>Time: 16H</li> <li>Examine the appearance and functions after taken out at room temperature for 24H.</li> </ol>	The appearance of the product, and electrical properties to meet the requirements.
Solder Heat Resistance	<ol> <li>Lead pins of the unit are soaked in solder bath. IR Reflow - Temperature: 270±5°C, Time: 10±0.5s.</li> <li>Examine the appearance and functions after the test.</li> </ol>	
High Humidity	<ol> <li>Temperature range: 85°C</li> <li>Humidity Range: 90%~95% R.H.</li> <li>Cycle times: 96H</li> <li>Examine the appearance and functions after taken out at room temperature for 24H.</li> </ol>	
Adhesion Test	<ol> <li>Subject the soldered device on test PCB. (Reflow)</li> <li>Then apply 0.5Kg(5N) of force for 10±1 sec in the direction of parallel to the substrate.</li> </ol>	



#### **ACR1004U**

Request Samples



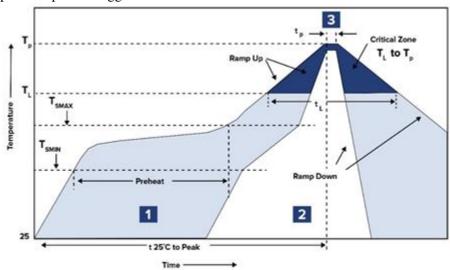
Check Inventory



10.0 x 4.0 x 1.5 mm RoHS/RoHS II Compliant MSL Level = N/A

#### **Reflow Profile**

The chip antenna can be assembled using the following Pb-free assembly. According to the standard IPC/JEDEC J-STD-020C, the temperature profile suggested is as follows:



Zone	Description	Temperature	Times	
1	Preheat	$T_{SMIN} \sim T_{SMAX}$ 150°C ~ 200°C	60 ~ 120 sec	
2	Ramp-Up	T <sub>SMAX</sub> ~ T <sub>P</sub> : 3 °C/s		
3	Reflow	T <sub>L</sub> 217°C	30 ~ 100 sec	
3	Peak heat	T <sub>P</sub> 260°C	5 sec (max)	
	Ramp-Down	6 °C/s		
Time from 25°C to Peak Temperature		8 minutes (max)		
Composition of solder paste		96.5Sn/3Ag/0.5Cu		
Solder Paste Model		SHENMAO PF606-P26		

### Soldering with Iron

- Soldering Iron Temperature : 270±10 °C
- Apply pre-heating at 120 °C for 2~3 min.
- Complete soldering for each terminal within 3 s .
  - o If the soldering iron temperature exceeds 270±10 °C or 3 seconds, it can damage the component.

<u>Note</u>: All temperature measure points are on top surface of the component. If temperature goes over the recommend, it will cause surface peeling or damage to the component.



#### **ACR1004U**

Request Samples



Check Inventory (>)



10.0 x 4.0 x 1.5 mm RoHS/RoHS II Compliant MSL Level = N/A

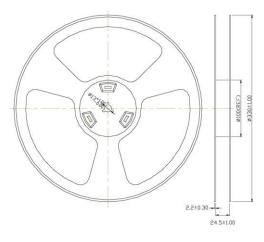
#### **Precautions**

- Do not direct solder onto the gold electrode of the antenna pattern.
- Do not use the chip antenna in a corrosive gaseous atmosphere for example sulfur gas, chlorine gas.

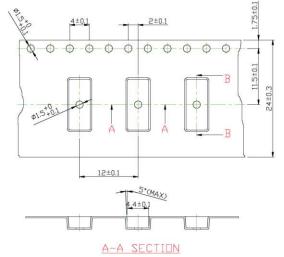
#### **Packaging Information**

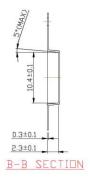
Number of pieces/tape: 2000

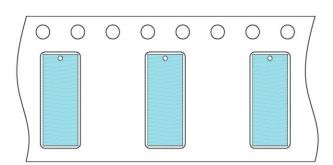
Blister tape to IEC 286-3, Polyester



Unit: mm







ATTENTION: Abracon LLC's products are COTS – Commercial-Off-The-Shelf products; suitable for Commercial, Industrial and, where designated, Automotive Applications. Abracon's products are not specifically designed for Military, Aviation, Aerospace, Life-dependent Medical applications or any application requiring high reliability where component failure could result in loss of life and/or property. For applications requiring high reliability and/or presenting an extreme operating environment, written consent and authorization from Abracon LLC is required. Please contact Abracon LLC for more information.



5101 Hidden Creek Ln Spicewood TX 78669 Phone: 512-371-6159 | Fax: 512-351-8858 For terms and conditions of sales, please visit: www.abracon.com

REVISED: 01-03-20

ABRACON IS ISO9001-2015 CERTIFIED